1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Extremely low leakage current I_R = 110 nA
- Reverse voltage: V_R ≤ 100 V
- Average forward current: I_{F(AV)} ≤ 3 A
- High power capability due to clip-bonding technology
- High temperature T_i ≤ 175 °C
- Small and flat lead SMD plastic package
- · Qualified according to AEC-Q101 and recommended for use in automotive applications
- Capable for reflow and wave soldering

3. Applications

- · Low voltage rectification
- High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Reverse polarity protection
- · Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 160 °C	-	-	3	Α
V _R	reverse voltage	T _j = 25 °C	-	-	100	٧
V _F	forward voltage	I_F = 3 A; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C	-	710	770	mV
I _R	reverse current	V_R = 100 V; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C	-	110	450	nA



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		K _[C -A
2	А	anode	1 2 CFP5 (SOD128)	sym001

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PMEG10030ELP-Q		plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128		

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG10030ELP-Q	DJ

Product data sheet

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	δ = 1; T _{sp} = 155 °C		-	4.2	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 55 °C	[1]	-	3	A
		δ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 160 °C		-	3	A
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	70	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	750	mW
			[3]	-	1250	mW
			[1]	-	2500	mW
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ιι (<u>)</u> -α <i>)</i>	thermal resistance from]	[1] [2]	-	-	200	K/W
	junction to ambient		[1] [3]	-	-	120	K/W
			[1] [4]	-	-	60	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

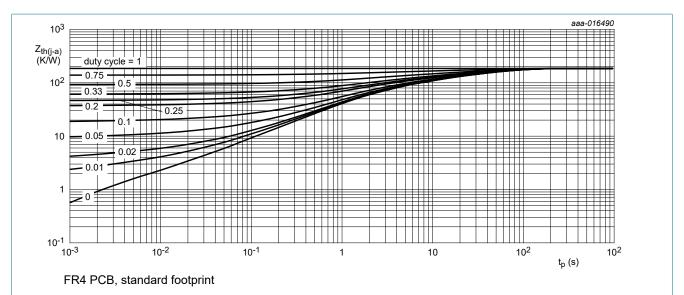
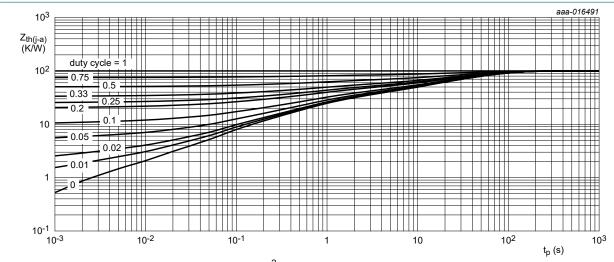
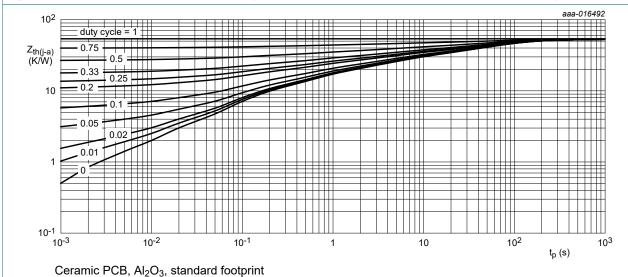


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



PMEG10030ELP-Q

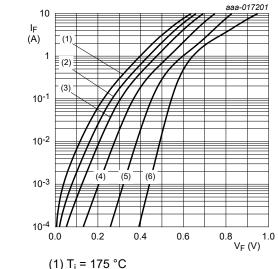
Fig. 3.

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)R}	reverse breakdown voltage	I_R = 1 mA; t_p = 300 μs; δ = 0.02; T_j = 25 °C	100	-	-	V
V _F	forward voltage	I_F = 0.1 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	455	510	mV
		I_F = 0.5 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	535	605	mV
		I_F = 0.7 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	565	640	mV
		I_F = 1 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	600	670	mV
		I_F = 1.6 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	645	720	mV
		I_F = 2 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	670	740	mV
		I_F = 3 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	710	770	mV
		I_F = 3 A; $t_p \le 300 \ \mu s$; δ ≤ 0.02; T_j = 125 °C	-	575	680	mV
R	reverse current	$V_R = 10 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	15	-	nA
		$V_R = 60 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	35	-	nA
		$V_R = 100 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	110	450	nA
		$V_R = 100 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 125 ^{\circ}\text{C}$	-	220	1500	μΑ
C_d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	200	-	pF
		V _R = 4 V; f = 1 MHz; T _j = 25 °C	-	120	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	78	-	pF
rr	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	8	-	ns
/ _{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A/}\mu\text{s}; T_j = 25 °C$	-	580	-	mV



(2) $T_i = 150 \,^{\circ}\text{C}$

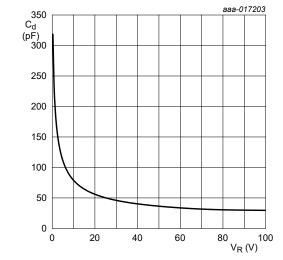
 $(3) T_i = 125 °C$

 $(4) T_i = 85 ^{\circ}C$

(5) $T_i = 25 °C$

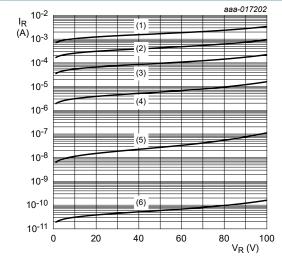
(6) $T_i = -40 \, ^{\circ}\text{C}$

Fig. 4. Forward current as a function of forward voltage; typical values



 $f = 1 MHz; T_{amb} = 25 °C$

Diode capacitance as a function of reverse Fig. 6. voltage; typical values



(1) $T_j = 175 \, ^{\circ}C$

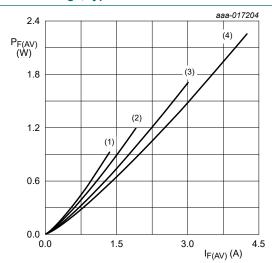
(2) $T_i = 150 \, ^{\circ}\text{C}$

(3) $T_i = 125 \,^{\circ}\text{C}$

 $(4) T_{j} = 85 ^{\circ}C$

(5) $T_i = 25 °C$ (6) $T_i = -40 \, ^{\circ}\text{C}$

Fig. 5. Reverse current as a function of reverse voltage; typical values



T_i = 175 °C

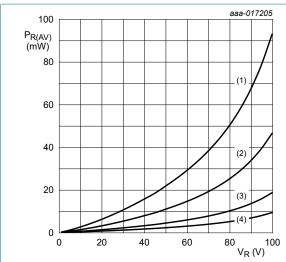
 $(1) \delta = 0.1$

 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

 $(4) \delta = 1$

Average forward power dissipation as a function of average forward current; typical values



 $T_i = 150 \,^{\circ}C$

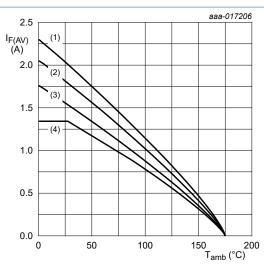
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

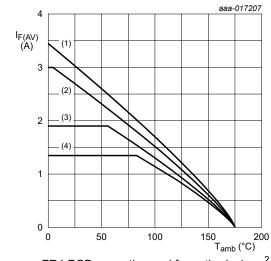
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_j = 175 \,{}^{\circ}\text{C}$

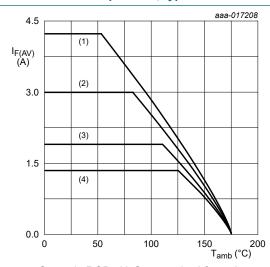
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

T_i = 175 °C

 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values

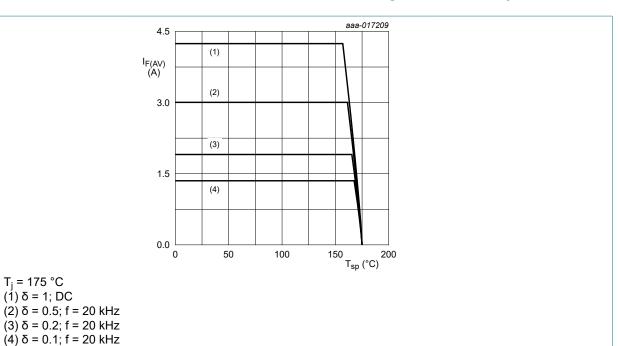
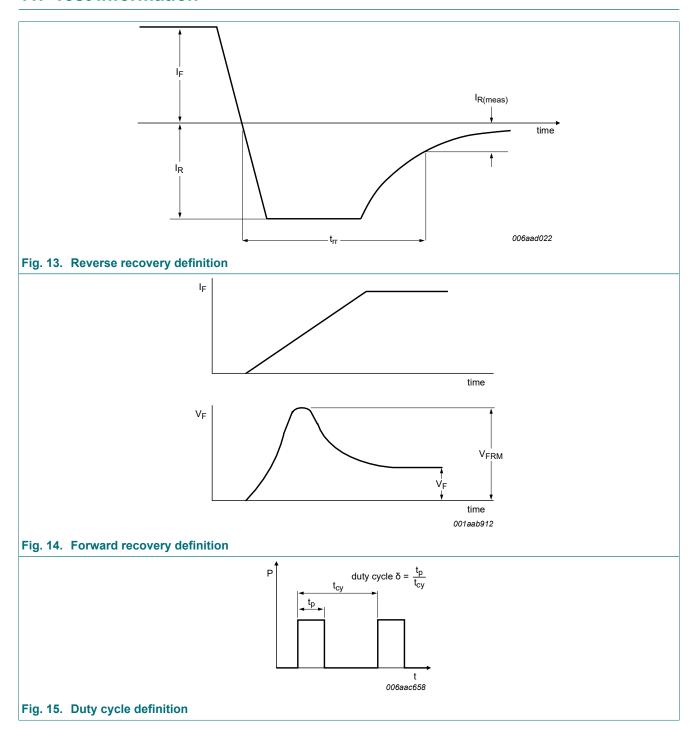


Fig. 12. Average forward current as a function of solder point temperature; typical values

11. Test information

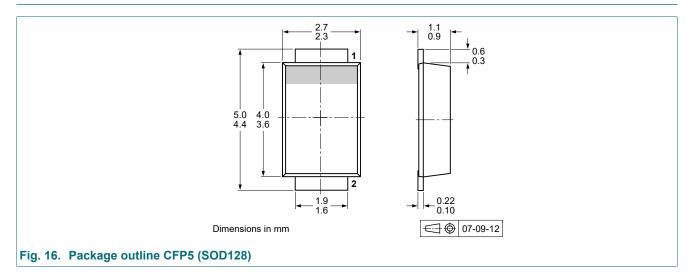


The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

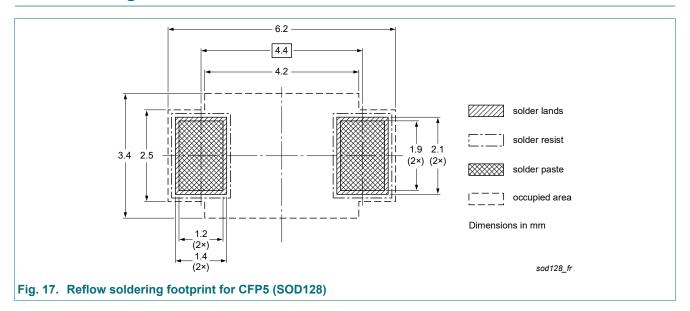
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

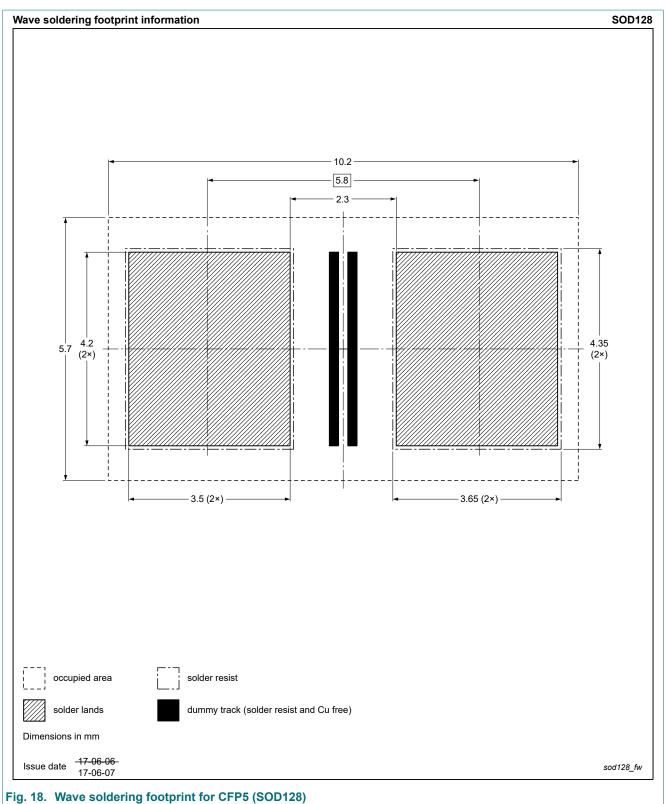


13. Soldering



Product data sheet

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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG10030ELP-Q v.1	20210722	Product data sheet	-	-

Product data sheet

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PMEG10030ELP-Q

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